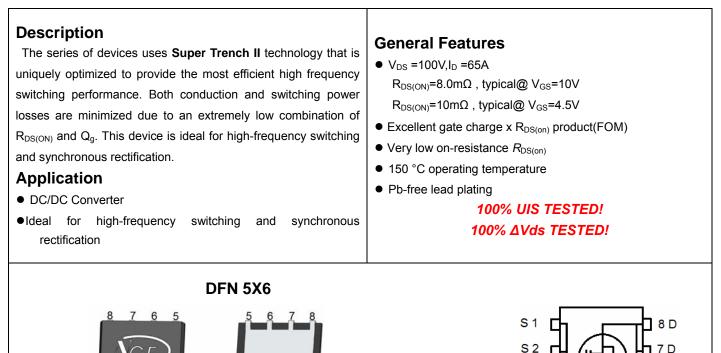


## NCE N-Channel Super Trench II Power MOSFET



Package Marking and Ordering Information

**Top View** 

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P090N10AGU	NCEP090N10AGU	DFN5X6-8L	-	-	-

## Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

**Bottom View** 

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	65	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	47	А
Pulsed Drain Current	I <sub>DM</sub>	260	А
Maximum Power Dissipation	PD	85	W
Derating factor		0.68	W/℃
Single pulse avalanche energy (Note 4)	E <sub>AS</sub>	288	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case	R <sub>eJC</sub>	1.47	°C <i>I</i> W	
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S 3

G 4

6 D

5 D

**Schematic Diagram** 



## Electrical Characteristics (T<sub>c</sub>=25<sup>°</sup>Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	· ·		·	•		•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	100		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)	· ·		·	•		•
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	1.1	1.7	2.5	V
Drain-Source On-State Resistance		V <sub>GS</sub> =10V, I <sub>D</sub> =32.5A	-	8.0	9.0	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =32.5A	-	10.0	11.5	
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =32.5A		50	-	S
Dynamic Characteristics (Note3)						
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, F=1.0MHz	-	2600	-	pF
Output Capacitance	C <sub>oss</sub>		-	230	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	27	-	pF
Switching Characteristics (Note 3)	· ·		·	•		•
Turn-on Delay Time	t <sub>d(on)</sub>		-	13	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =50V,I <sub>D</sub> =32.5A V <sub>GS</sub> =10V,R <sub>G</sub> =1.6Ω	-	10	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	30	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	8	-	nS
Total Gate Charge	Qg		-	54	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =50V,I <sub>D</sub> =32.5A,	-	10	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	14	-	nC
Drain-Source Diode Characteristics	· ·		·	•		
Diode Forward Voltage (Note 2)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =32.5A	-	-	1.2	V
Diode Forward Current	Is		-	-	65	Α
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C, I_F = 32.5A$	-	55	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	98	-	nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

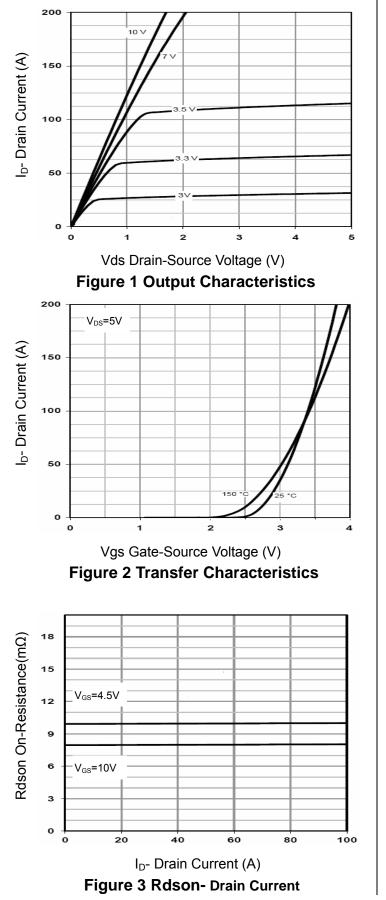
2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

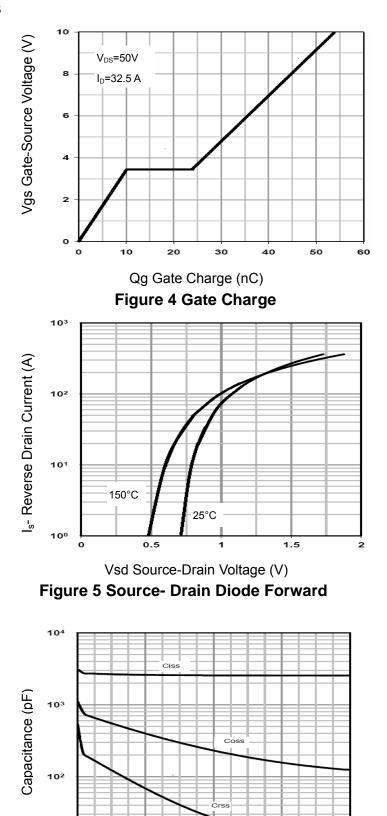
3. Guaranteed by design, not subject to production

4. EAS condition : Tj=25  $^\circ C$  ,V\_DD=50V,V\_G=10V,L=0.25mH,Rg=25 $\Omega$ 



## **Typical Electrical and Thermal Characteristics**





10<sup>1</sup>

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25

50

Vds Drain-Source Voltage (V)

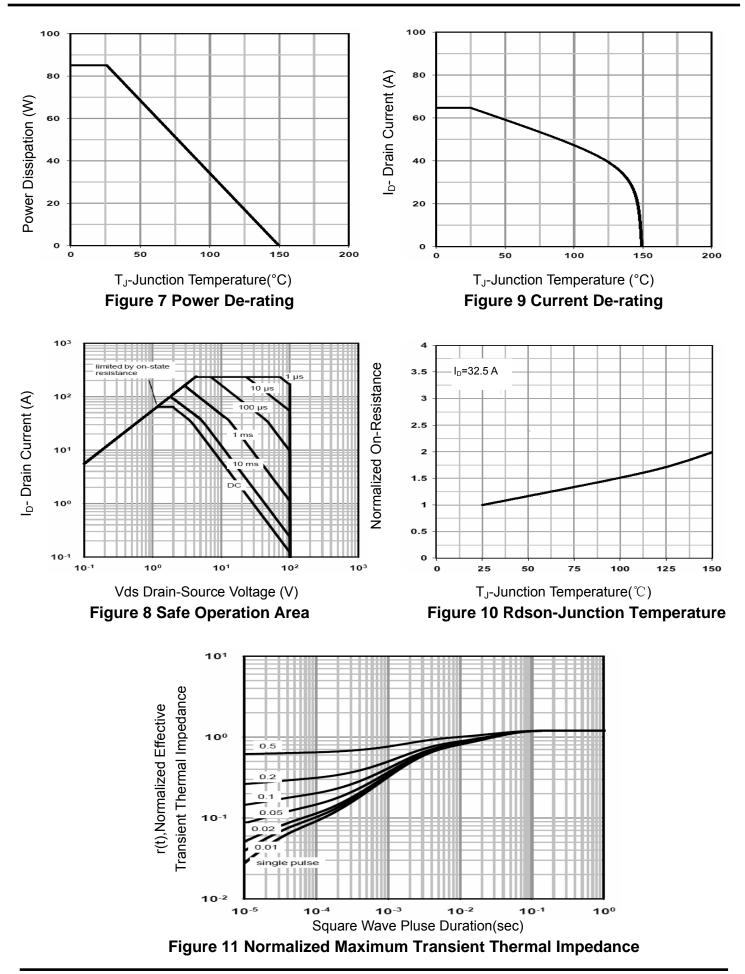
Figure 6 Capacitance vs Vds

100

75

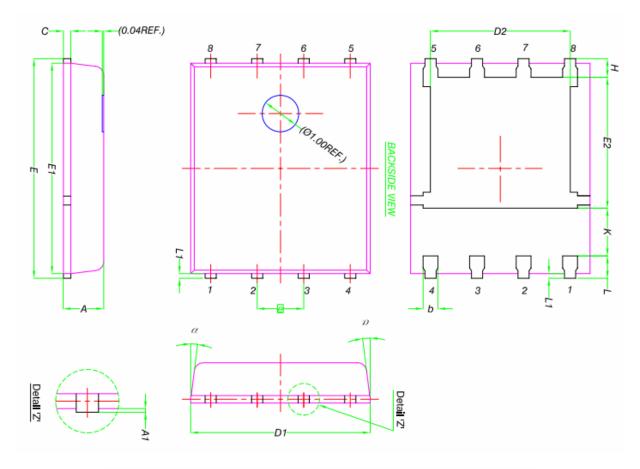


# NCEP090N10AGU

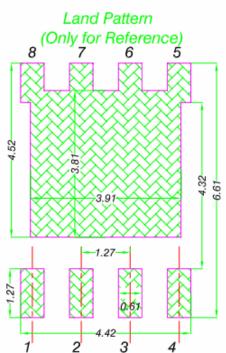




## DFN5X6-8L Package Information



	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
А	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
E	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
к	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	-	12°	





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